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<u>Texas Instruments</u> <u>SN74LVTH162240DGGR</u>

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Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of SN74LVTH162240DGGR - IC INVERTER QUAD 4-INPUT 48TSSOP

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www.ti.com

SN54LVTH162240, SN74LVTH162240 3.3-V ABT 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS685F-MARCH 1997-REVISED NOVEMBER 2006

FEATURES

- Members of the Texas Instruments Widebus[™]
 Family
- State-of-the-Art Advanced BiCMOS
 Technology (ABT) Design for 3.3-V Operation
 and Low Static-Power Dissipation
- Output Ports Have Equivalent 22- Ω Series Resistors, So No External Resistors Are Required
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54LVTH162240... WD PACKAGE SN74LVTH162240... DGG OR DL PACKAGE (TOP VIEW)

				1
1 <u>OE</u> [1	\cup	48	2 <u>0E</u>
1Y1 [2		47] 1A1
1Y2 [3		46] 1A2
GND[4		45	GND
1Y3 [5		44] 1A3
1Y4 [6		43] 1A4
V _{CC} [7		42] v _{cc}
2Y1 [8		41	2A1
2Y2	9		40	2A2
GND[10		39	GND
2Y3 [11		38] 2A3
2Y4[12		37	2A4
3Y1[13		36] 3A1
3Y2 [14		35] 3A2
GND[15		34	GND
3Y3[16		33] 3A3
3Y4 [17		32] 3A4
V _{CC} [18		31] v _{cc}
4Y1 [19		30] 4A1
4Y2[20		29] 4A2
GND[21			GND
4Y3 [22] 4A3
4Y4 [23		26] 4A4
4 <u>OE</u> [24		25] 3 <u>OE</u>

DESCRIPTION/ORDERING INFORMATION

The 'LVTH162240 devices are 16-bit buffers/drivers designed specifically for low-voltage (3.3-V) V_{CC} operation and to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. They have the capability to provide a TTL interface to a 5-V system environment.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer and provide inverting outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

The outputs, which are designed to source or sink up to 12 mA, include equivalent $22-\Omega$ series resistors to reduce overshoot and undershoot.

When V_{CC} is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

These devices are fully specified for hot-insertion applications using I_{off} and power-up 3-state. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

The SN54LVTH162240 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74LVTH162240 is characterized for operation from -40° C to 85° C.

ORDERING INFORMATION

T _A	PACKAG	6E ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
		Dool of 1000	74LVTH162240DLRG4		
	SSOP – DL	Reel of 1000	SN74LVTH162240DLR	1.V/T1.14.000.40	
4000 (0500	350P - DL	T b £ 0.5	74LVTH162240DLG4	LVTH162240	
–40°C to 85°C		Tube of 25	SN74LVTH162240DL		
	T000D D00	D1 -4 0000	74LVTH162240DGGRE4	L \/TL I4 COO 40	
	TSSOP – DGG	Reel of 2000	SN74LVTH162240DGGR	LVTH162240	

Package drawings, standard packing quantities, thermal data, symbolization, and PCB guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each 4-bit buffer)

INP	UTS	OUTPUT
ŌĒ	Α	Υ
L	Н	L
L	L	Н
Н	Χ	Z

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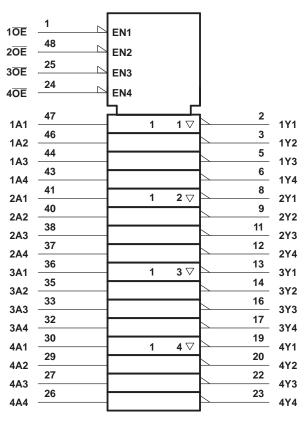
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LOGIC SYMBOL(1)



(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

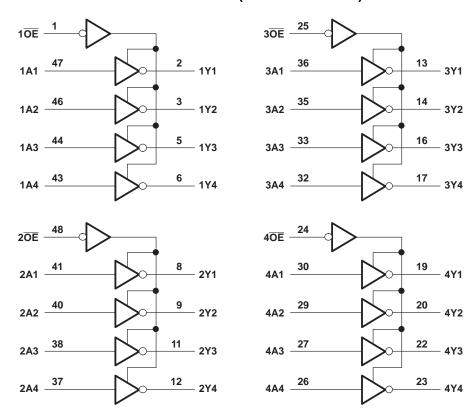
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LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4.6	V
VI	Input voltage range ⁽²⁾		-0.5	7	V
Vo	Voltage range applied to any output in the high-impeda	-0.5	7	V	
Vo	Voltage range applied to any output in the high state(2	-0.5	V _{CC} + 0.5	V	
Io	Current into any output in the low state			30	mA
Io	Current into any output in the high state (3)			30	mA
I _{IK}	Input clamp current	V _I < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
0	Declare thermal impadence (4)	DGG package		89	°C/W
θ_{JA}	Package thermal impedance (4)	DL package		94	-0/00
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽³⁾ This current flows only when the output is in the high state and $V_O > V_{CC}$.

⁴⁾ The package thermal impedance is calculated in accordance with JESD 51.



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Recommended Operating Conditions(1)

			SN54LVTH16	2240 ⁽²⁾	SN74LVTH	UNIT	
			MIN	MAX	MIN	MAX	UNII
V_{CC}	Supply voltage		2.7	3.6	2.7	3.6	V
V _{IH}	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage			5.5		5.5	V
I _{OH}	High-level output current			-12		-12	mA
I _{OL}	Low-level output current			12		12	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _C	Power-up ramp rate		200		200		μs/V
T _A	Operating free-air temperature		-55	125	-40	85	°C

⁽¹⁾ All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

⁽²⁾ Product preview



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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEC	T CONDITIONS	SN5	4LVTH1622	240 ⁽¹⁾	SN74	LVTH1622	240	UNIT	
PAR	AMETER	IES	T CONDITIONS	MIN	TYP ⁽²⁾	MAX	MIN	VTH162240 TYP ⁽²⁾ MAX -1.2 0.8 10 ±1 1 -5 ±100 500 -750 5 -5 ±100 ±100 0.19 5 0.19	UNII		
V_{IK}		$V_{CC} = 2.7 V,$	$I_I = -18 \text{ mA}$			-1.2			-1.2	V	
V_{OH}		V _{CC} = 3 V,	I _{OH} = -12 mA	2			2			V	
V_{OL}		$V_{CC} = 3 V$,	I _{OL} = 12 mA			0.8			8.0	V	
		$V_{CC} = 0 \text{ or } 3.6 \text{ V},$	V _I = 5.5 V			10			10		
I _I	Control inputs	V _{CC} = 3.6 V,	V _I = V _{CC} or GND			±1			±1	μΑ	
•	Data V _{CC} = 3.6 V	V - 26 V	$V_I = V_{CC}$			1			1		
inputs	v _{CC} = 3.6 v	$V_I = 0$			-5			- 5			
I _{off}		$V_{CC} = 0$,	V_I or $V_O = 0$ to 4.5 V						±100	μΑ	
		V - 2 V	V _I = 0.8 V	75			75				
La co	(hold) Data	$V_{CC} = 3 V$	V _I = 2 V	-75			-75			μΑ	
'I(noia)	inputs	V _{CC} = 3.6 V, ⁽³⁾	V _I = 0 to 3.6 V							μ.,	
I _{OZH}		V _{CC} = 3.6 V,	V _O = 3 V			5			5	μΑ	
I _{OZL}		$V_{CC} = 3.6 \text{ V},$	V _O = 0.5 V			- 5			- 5	μΑ	
I _{OZPU}		$\frac{V_{CC}}{OE} = 0 \text{ to } 1.5 \text{ V}, V_{CC}$	$_{0} = 0.5 \text{ V to 3 V},$			±100 ⁽⁴⁾			±100	μΑ	
I _{OZPD}		$\frac{V_{CC}}{OE}$ = 1.5 V to 0, V_{C}	$_{0} = 0.5 \text{ V to 3 V},$			±100 ⁽⁴⁾			±100	μΑ	
		V _{CC} = 3.6 V,	Outputs high			0.19			0.19		
I_{CC}		$I_0 = 0$	Outputs low			5			5	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			0.19			0.19		
ΔI _{CC} ⁽⁵⁾		$V_{CC} = 3 \text{ V to } 3.6 \text{ V},$ Other inputs at V_{CC}	One input at V _{CC} – 0.6 V, or GND			0.2			0.2	mA	
C _i		V _I = 3 V or 0			4			4		pF	
Co		$V_0 = 3 \text{ V or } 0$			9			9		pF	

⁽¹⁾ Product preview

⁽²⁾ All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

⁽³⁾ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

⁽⁴⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested.

⁽⁵⁾ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.



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Switching Characteristics

over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			SN54LVTH162240 ⁽¹⁾				SN74LVTH162240					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V			V _{CC} = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	MIN	TYP ⁽²⁾	MAX	MIN	MAX	
t _{PLH}	А	Υ	1	4.2		5	1	2.5	4		4.6	
t _{PHL}	A	r	1	4.2		5	1	2.9	4		4.6	ns
t _{PZH}	ŌĒ	Υ	1	5		5.5	1	2.8	4.8		5.7	
t _{PZL}	OE	ř	1	4.9		5.1	1	2.8	4.7		4.9	ns
t _{PHZ}	ŌĒ	Υ	1.9	4.9		5.4	2	3.5	4.7		5.2	
t _{PLZ}	OE	ř	1.9	4.7		4.8	2	3.4	4.5		4.5	ns
t _{sk(LH)}								,	0.5		0.5	
t _{sk(HL)}									0.5		0.5	ns

Product preview

All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



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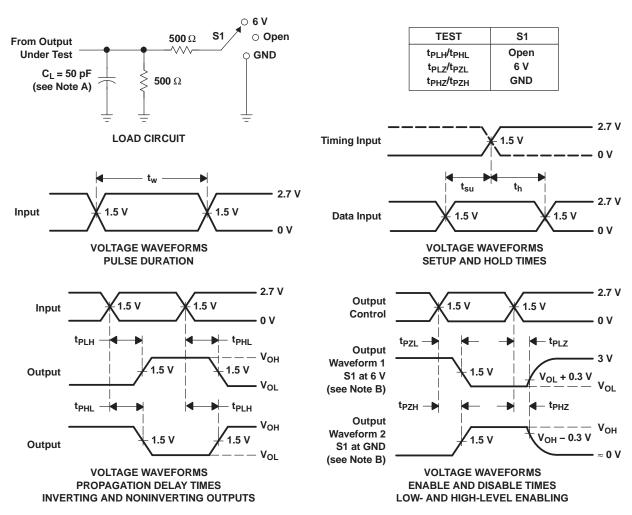
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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74LVTH162240DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH162240DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH162240DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVTH162240DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH162240DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH162240DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVTH162240DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74LVTH162240 :

● Enhanced Product: SN74LVTH162240-EP

NOTE: Qualified Version Definitions:

Enhanced Product - Supports Defense, Aerospace and Medical Applications

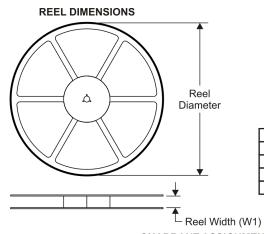
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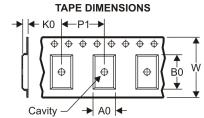




11-Mar-2008

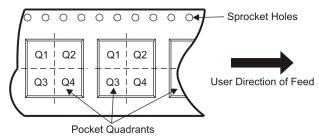
TAPE AND REEL INFORMATION





A0 Dimension designed to accommodate the component width	
D: : 1 : 11	
B0 Dimension designed to accommodate the component length	ı
K0 Dimension designed to accommodate the component thickn	ess
W Overall width of the carrier tape	
P1 Pitch between successive cavity centers	

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

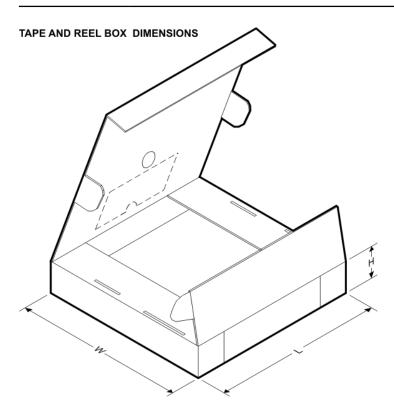
Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVTH162240DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74LVTH162240DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVTH162240DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
SN74LVTH162240DLR	SSOP	DL	48	1000	346.0	346.0	49.0



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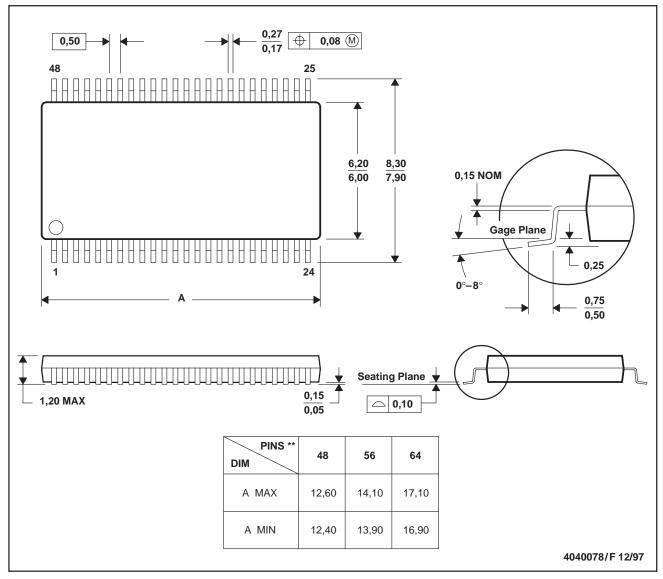
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





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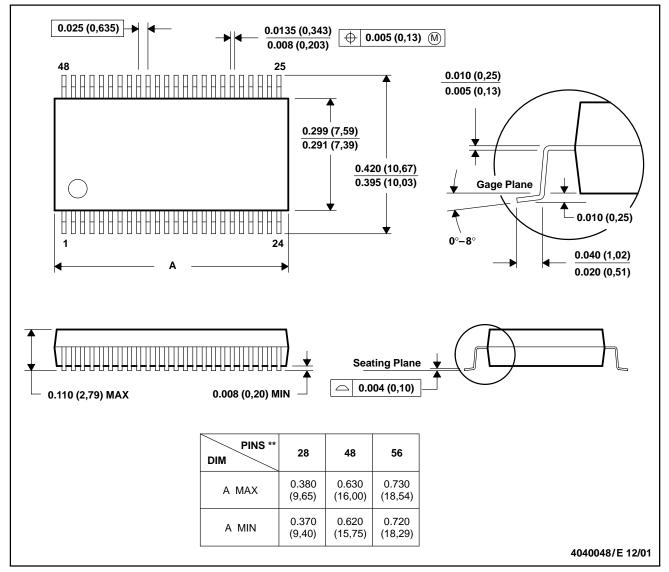
MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118





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